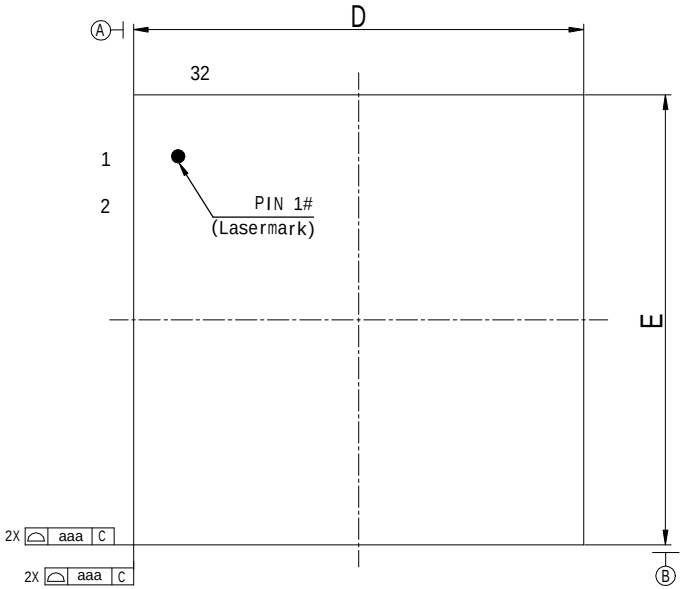
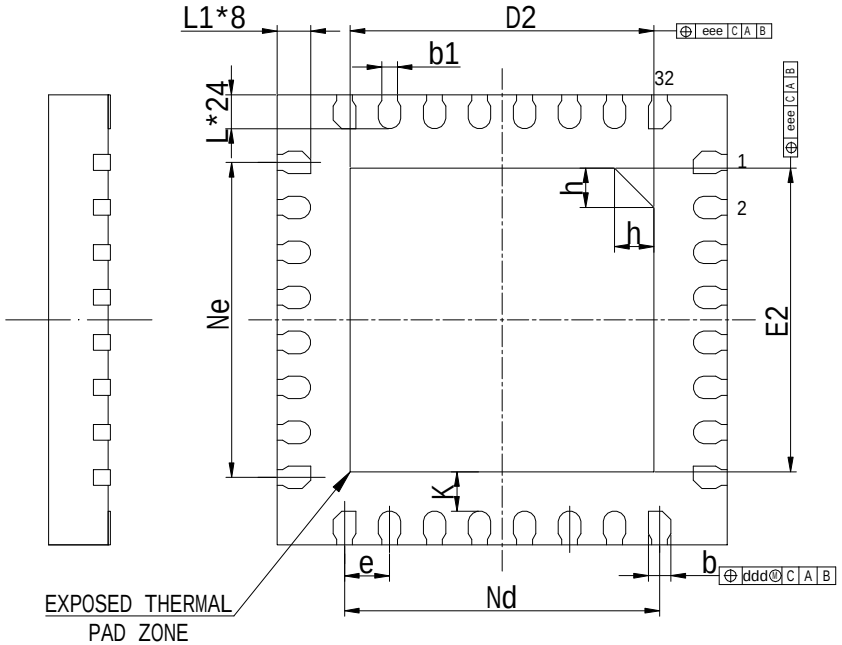


TOP VIEW



BOTTOM VIEW

		SYMBOL	MILLIMETER		
			MIN	NOM	MAX
TOTAL THICKNESS		A	0.50	0.55	0.60
STAND OFF		A1	0	0.02	0.05
LEAD WIDTH		b	0.15	0.20	0.25
LEAD END WIDTH		b1	0.14REF		
L/F THICKNESS		c	0.152REF		
BOOY SIZE	X	D	3.90	4.00	4.10
	Y	E	3.90	4.00	4.10
LEAD PITCH		e	0.40BSC		
EP SIZE	X	D2	2.60	2.70	2.80
	Y	E2	2.60	2.70	2.80
ACCUMULATIVE PITCH	X	Nd	2.80BSC		
	Y	Ne	2.80BSC		
LEAD LENGTH		L	0.25	0.30	0.35
		L1	0.23	0.28	0.33
SPACING BETWEEN LEAD EDGE TO E-PAD EDGE		K	0.35REF		
PIN 1# ID		h	0.30	0.35	0.40
PACKAGE EDGE TOLERANCE		aaa	0.10		
MOLD FLATNESS		bbb	0.10		
COPLANARITY		ccc	0.08		
LEAD OFFSET		ddd	0.10		
EXPOSED PAD OFFSET		eee	0.10		

SIDE VIEW

**

华天科技（西安）有限公司

HuaTian Technology(Xi'an)CO.,LTD

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